


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	ANALOG MEMS SENSORS/26/16234	
1.3 Title of PCN	Qualify ST Shenzhen as the alternative Back End source for SO16 Narrow Dual Die	
1.4 Product Category	See product list	
1.5 Issue date	2026-04-09	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Domenico ARRIGO
2.1.2 Marketing Manager	Alessandro MOSCATELLI
2.1.3 Quality Manager	Paolo MORETTI

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Product transfer from one site to another site, even if test or process line is qualified	New : Shenzhen

4. Description of change

	Old	New
4.1 Description	Assembly plant : - AMKOR ATP1	Assembly plant : - AMKOR ATP1 - ST Shenzhen
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change

5.1 Motivation	Increase Assembly and Test Volume Capacity for SO16 Narrow Dual Die products
5.2 Customer Benefit	MANUFACTURING FLEXIBILITY

6. Marking of parts / traceability of change

6.1 Description	New Finished good codes
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7. Timing / schedule

7.1 Date of qualification results	2026-06-15
7.2 Intended start of delivery	2026-07-10
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

9. Attachments (additional documentations)

16234 Public product.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	L6563H	
	L6563HTR	
	L6566A	
	L6566ATR	
	L6566B	
	L6566BH	
	L6566BHTR	
	L6566BTR	
	L6591	
	L6591TR	
L6668	L6668	
L6668TR	L6668TR	

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